

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	12	control with depth with ion implant\$6 with known	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/02/16 21:37
L2	6	mechanical stress with fracture with known and semiconductor	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/02/16 21:38
L3	1	mechanical stress with fracture with known and semiconductor and (jet or blade)	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/02/16 21:38
L4	36	mechanical stress with fracture and semiconductor and (jet or blade)	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/02/16 21:39
L5	392	separate with wafer with (jet or blade) and semiconductor and (jet or blade)	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/02/16 21:43
L6	13	separate with wafer with (jet or blade) with known and semiconductor and (jet or blade)	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/02/16 21:44
L7	0	soi and separate with wafer with (jet or blade) with known and semiconductor and (jet or blade)	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/02/16 21:45

L8	48	soi and separate with wafer with (jet or blade) and semiconductor and (jet or blade)	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/02/16 21:45
L10	1354	(438/460).CCLS.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/02/16 22:11
S1	4953	hydrogen with implant \$3	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/08/24 16:17
S2	428	rare gas with implant \$3	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/08/24 16:17
S3	92851	anneal	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/08/24 16:18
S4	1095535	anneal\$3 or diffus\$3	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/08/24 16:19
S5	253	S1 and S2 and S4	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/08/24 16:19
S6	45	S1 and S2 and S4 and fracture	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/08/24 16:19

S7	1174	helium with implant \$3	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/08/24 16:27
S8	83	S1 and S7 and S4 and fracture	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/08/24 16:27
S9	1	jp11087668	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/08/24 16:31
S10	1	jp09239174	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/08/24 16:32
S11	1058	nakajima-takeshi.in.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/08/24 16:33
S12	2	nakajima-takeshi.in. and S1 and S7	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/08/24 16:33
S13	2	("6150239").PN.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/09/15 09:32
S14	282	smith-bradley-\$.xp.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/02/10 20:22

S15	103	smith-bradley \$.xp. and implant\$3	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/02/10 20:22
S16	0	mitsubishi and implant \$3 with hydrogen and implant\$3 with helium	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/02/10 20:50
S17	796	implant\$3 with hydrogen and implant \$3 with helium	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/02/10 20:50
S18	17	implant\$3 with hydrogen and implant \$3 with helium and mitsubishi	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/02/10 20:51
S19	0	implant\$3 with hydrogen and implant \$3 with helium and NAKAI-TETSUY-\$.in.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/02/10 20:53
S20	0	implant\$3 with hydrogen and implant \$3 with helium and nakai-tetsui-\$.in.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/02/10 20:53
S21	0	implant\$3 with hydrogen and implant \$3 with helium and tetsui-nakai-\$.in.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/02/10 20:53
S22	2	implant\$3 with hydrogen and implant \$3 with helium and tomizawa-kenji.in.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/02/10 20:54

S23	2	implant\$3 with helium and tomizawa-kenji.in.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/02/10 20:55
S24	13	implant\$3 and tomizawa-kenji.in.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/02/10 20:55

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